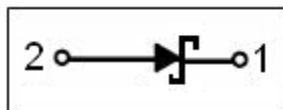


/ Descriptions**/ Features****/ Applications****/ Equivalent Circuit****/ Pinning****/ h_{FE} Classifications & Marking**

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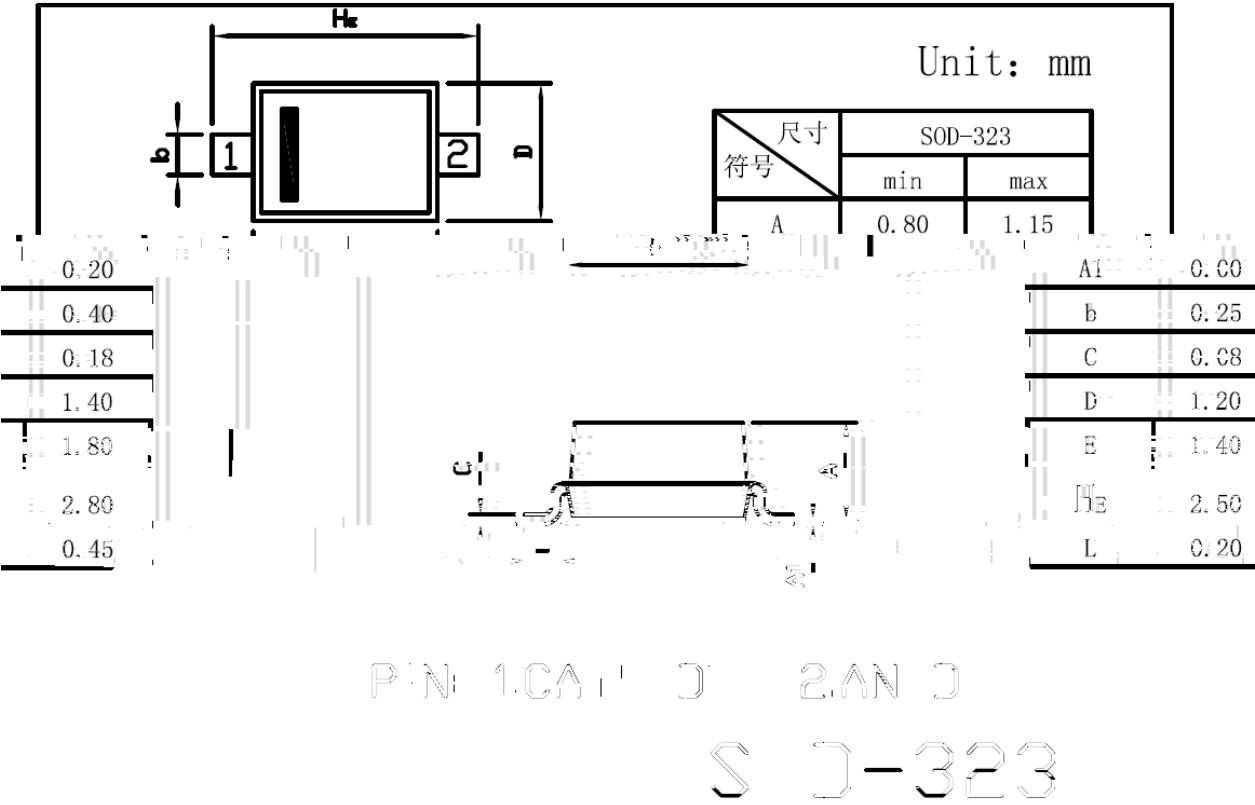
/ Absolute Maximum Ratings(Ta=25)

	θ		

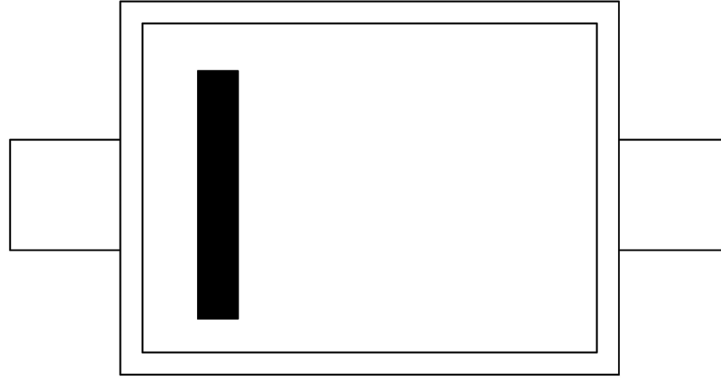
/ Electrical Characteristics(Ta=25)

		μ			
					μ
		Ω			

/ Package Dimensions



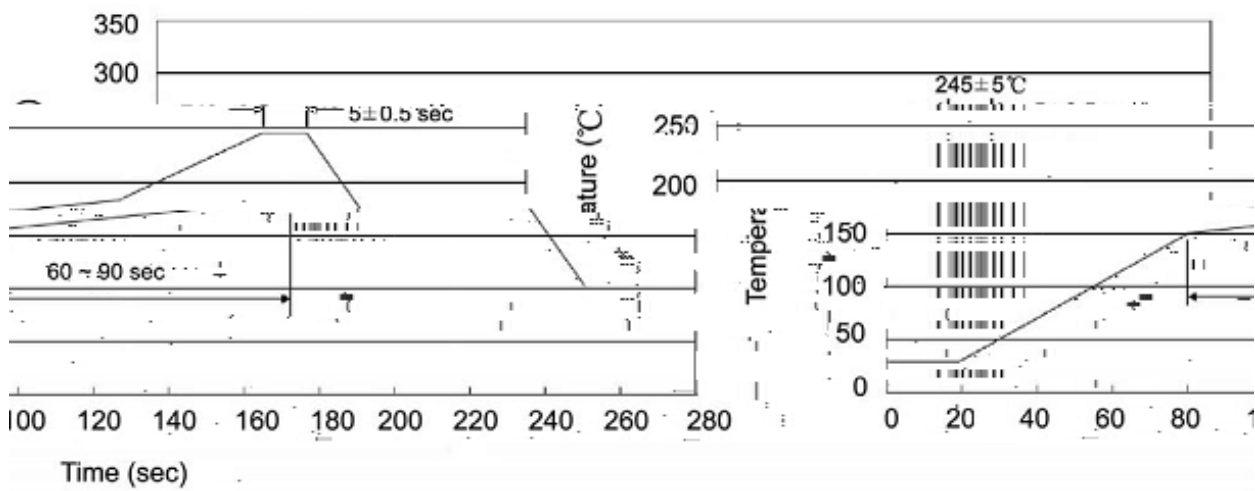
/ Marking Instructions



H

86

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± ± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 卷盘	卷盘 盒	只 盒	盒 箱	只 箱		盒	箱

/ Notices